

BFG93A; BFG93A/X

NPN 6 GHz wideband transistors

Rev. 05 — 26 November 2007

Product data sheet

IMPORTANT NOTICE

Dear customer,

As from October 1st, 2006 Philips Semiconductors has a new trade name - NXP Semiconductors, which will be used in future data sheets together with new contact details.

In data sheets where the previous Philips references remain, please use the new links as shown below.

<http://www.philips.semiconductors.com> use <http://www.nxp.com>

<http://www.semiconductors.philips.com> use <http://www.nxp.com> (Internet)

sales.addresses@www.semiconductors.philips.com use salesaddresses@nxp.com (email)

The copyright notice at the bottom of each page (or elsewhere in the document, depending on the version)

- © Koninklijke Philips Electronics N.V. (year). All rights reserved - is replaced with:

- © NXP B.V. (year). All rights reserved. -

If you have any questions related to the data sheet, please contact our nearest sales office via e-mail or phone (details via salesaddresses@nxp.com). Thank you for your cooperation and understanding,

NXP Semiconductors

NPN 6 GHz wideband transistors

BFG93A; BFG93A/X

FEATURES

- High power gain
- Low noise figure
- Gold metallization ensures excellent reliability.

APPLICATIONS

Wideband applications in the UHF and microwave range.

DESCRIPTION

NPN transistor in a 4-pin, dual-emitter SOT143B plastic package.

PINNING

| PIN | DESCRIPTION |
|-----------------|-------------|
| BFG93A | |
| 1 | collector |
| 2 | base |
| 3 | emitter |
| 4 | emitter |
| BFG93A/X | |
| 1 | collector |
| 2 | emitter |
| 3 | base |
| 4 | emitter |

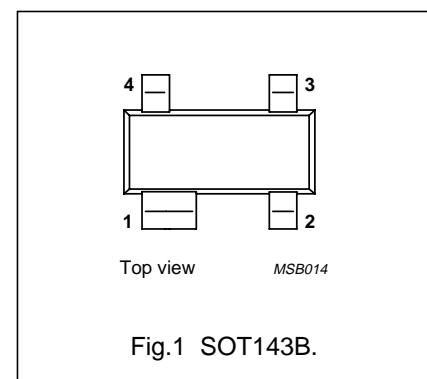


Fig.1 SOT143B.

MARKING

| TYPE NUMBER | CODE |
|-------------|------|
| BFG93A | R8% |
| BFG93A/X | %MX |

QUICK REFERENCE DATA

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------|-------------------------------|--|------|------|------|------|
| V_{CBO} | collector-base voltage | open emitter | – | – | 15 | V |
| V_{CEO} | collector-emitter voltage | open base | – | – | 12 | V |
| I_C | collector current (DC) | | – | – | 35 | mA |
| P_{tot} | total power dissipation | $T_s \leq 85^\circ\text{C}$ | – | – | 300 | mW |
| C_{re} | feedback capacitance | $I_C = i_c = 0$; $V_{CB} = 5$ V; $f = 1$ MHz | – | 0.6 | – | pF |
| f_T | transition frequency | $I_C = 30$ mA; $V_{CE} = 5$ V; $f = 500$ MHz | 4.5 | 6 | – | GHz |
| G_{UM} | maximum unilateral power gain | $I_C = 30$ mA; $V_{CE} = 8$ V; $T_{amb} = 25^\circ\text{C}$; $f = 1$ GHz | – | 16 | – | dB |
| | | $I_C = 30$ mA; $V_{CE} = 8$ V; $T_{amb} = 25^\circ\text{C}$; $f = 2$ GHz | – | 10 | – | dB |
| F | noise figure | $\Gamma_s = \Gamma_{opt}$; $I_C = 5$ mA; $V_{CE} = 8$ V; $T_{amb} = 25^\circ\text{C}$; $f = 1$ GHz | – | 1.7 | – | dB |

NPN 6 GHz wideband transistors

BFG93A; BFG93A/X

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 134).

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-----------|--------------------------------|--------------------------------------|------|------|------|
| V_{CBO} | collector-base voltage | open emitter | – | 15 | V |
| V_{CEO} | collector-emitter voltage | open base | – | 12 | V |
| V_{EBO} | emitter-base voltage | open collector | – | 2 | V |
| I_C | collector current (DC) | | – | 35 | mA |
| P_{tot} | total power dissipation | $T_s \leq 85^\circ\text{C}$; note 1 | – | 300 | mW |
| T_{stg} | storage temperature range | | –65 | +150 | °C |
| T_j | junction operating temperature | | – | 175 | °C |

Note

- T_s is the temperature at the soldering point of the collector pin.

THERMAL CHARACTERISTICS

| SYMBOL | PARAMETER | CONDITIONS | VALUE | UNIT |
|---------------|---|------------|-------|------|
| $R_{th\ j-s}$ | thermal resistance from junction to soldering point | note 1 | 290 | K/W |

Note

- T_s is the temperature at the soldering point of the collector pin.

CHARACTERISTICS $T_j = 25^\circ\text{C}$ unless otherwise specified.

| SYMBOL | PARAMETER | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|-----------|---------------------------------------|---|------|------|------|------|
| I_{CBO} | collector leakage current | $I_E = 0$; $V_{CB} = 5\text{ V}$ | – | – | 50 | nA |
| h_{FE} | DC current gain | $I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$ | 40 | 90 | – | |
| C_c | collector capacitance | $I_E = i_e = 0$; $V_{CB} = 5\text{ V}$; $f = 1\text{ MHz}$ | – | 0.9 | – | pF |
| C_e | emitter capacitance | $I_C = i_c = 0$; $V_{EB} = 5\text{ V}$; $f = 1\text{ MHz}$ | – | 1.9 | – | pF |
| C_{re} | feedback capacitance | $I_C = i_c = 0$; $V_{CB} = 5\text{ V}$; $f = 1\text{ MHz}$ | – | 0.6 | – | pF |
| f_T | transition frequency | $I_C = 30\text{ mA}$; $V_{CE} = 5\text{ V}$; $f = 500\text{ MHz}$ | 4.5 | 6 | – | GHz |
| G_{UM} | maximum unilateral power gain; note 1 | $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $T_{amb} = 25^\circ\text{C}$; $f = 1\text{ GHz}$ | – | 16 | – | dB |
| | | $I_C = 30\text{ mA}$; $V_{CE} = 8\text{ V}$; $T_{amb} = 25^\circ\text{C}$; $f = 2\text{ GHz}$ | – | 10 | – | dB |
| F | noise figure | $\Gamma_s = \Gamma_{opt}$; $I_C = 5\text{ mA}$; $V_{CE} = 8\text{ V}$; $T_{amb} = 25^\circ\text{C}$; $f = 1\text{ GHz}$ | – | 1.7 | – | dB |
| | | $\Gamma_s = \Gamma_{opt}$; $I_C = 5\text{ mA}$; $V_{CE} = 8\text{ V}$; $T_{amb} = 25^\circ\text{C}$; $f = 2\text{ GHz}$ | – | 2.3 | – | dB |

Note

- G_{UM} is the maximum unilateral power gain, assuming S_{12} is zero and $G_{UM} = 10 \log \frac{|S_{21}|^2}{(1 - |S_{11}|^2)(1 - |S_{22}|^2)}$ dB.

NPN 6 GHz wideband transistors

BFG93A; BFG93A/X

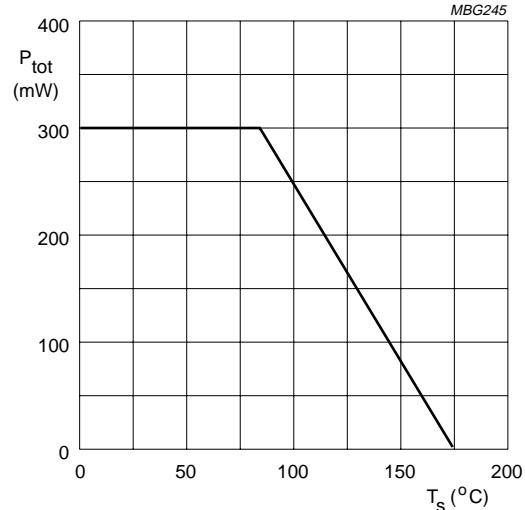


Fig.2 Power derating curve.

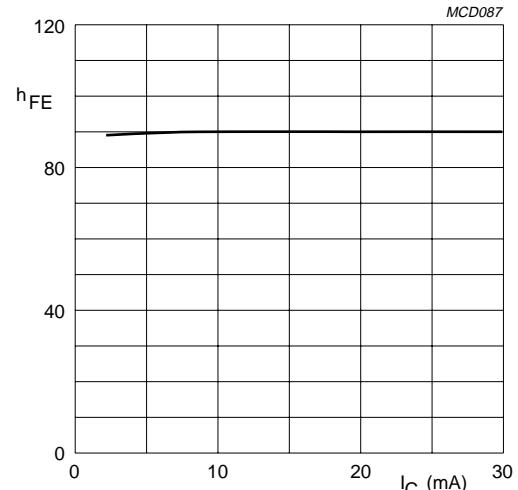
 $V_{CE} = 5$ V.

Fig.3 DC current gain as a function of collector current; typical values.

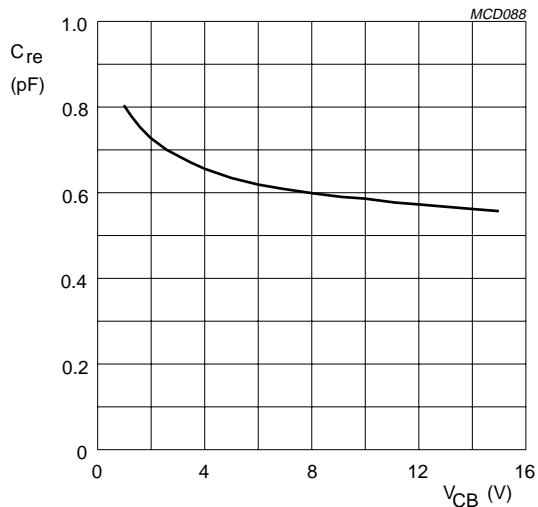
 $I_C = i_c = 0$; $f = 1$ MHz.

Fig.4 Feedback capacitance as a function of collector-base voltage; typical values.

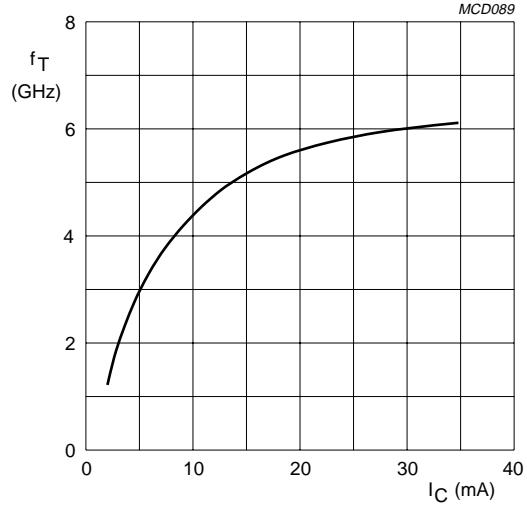
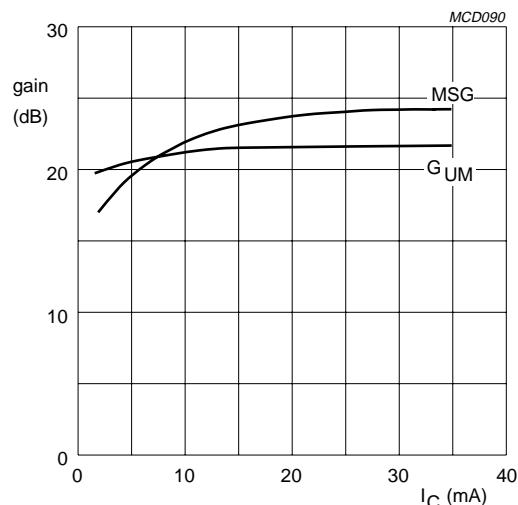
 $V_{CE} = 5$ V; $T_{amb} = 25$ $^{\circ}$ C; $f = 500$ MHz.

Fig.5 Transition frequency as a function of collector current; typical values.

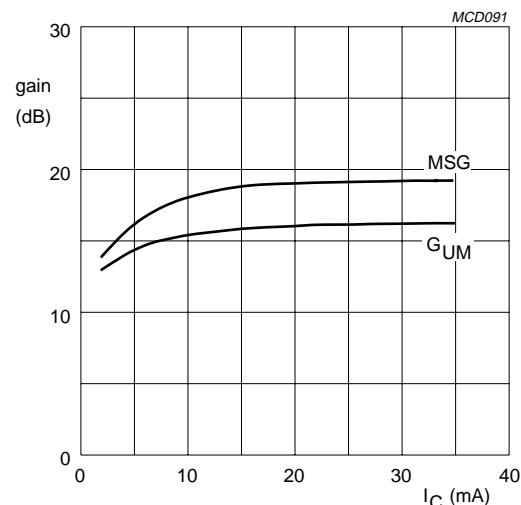
NPN 6 GHz wideband transistors

BFG93A; BFG93A/X



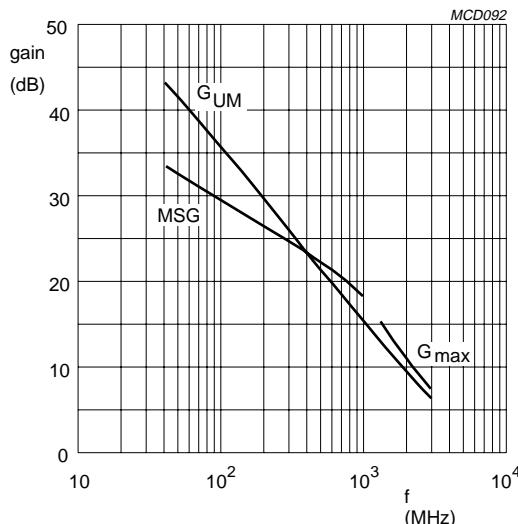
$V_{CE} = 8$ V; $f = 500$ MHz.

Fig.6 Gain as a function of collector current; typical values.



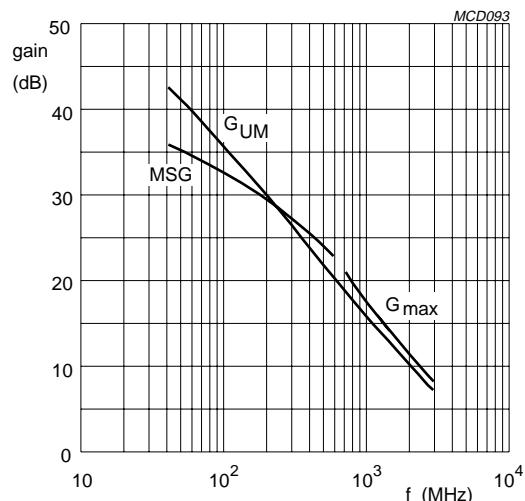
$V_{CE} = 8$ V; $f = 1$ GHz.

Fig.7 Gain as a function of collector current; typical values.



$V_{CE} = 8$ V; $I_C = 10$ mA.

Fig.8 Gain as a function of frequency; typical values.

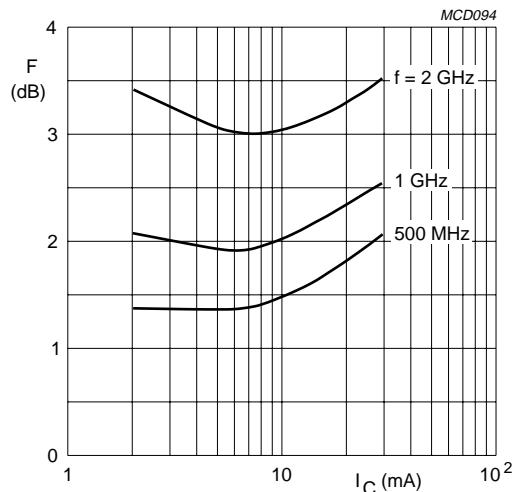


$V_{CE} = 8$ V; $I_C = 30$ mA.

Fig.9 Gain as a function of frequency; typical values.

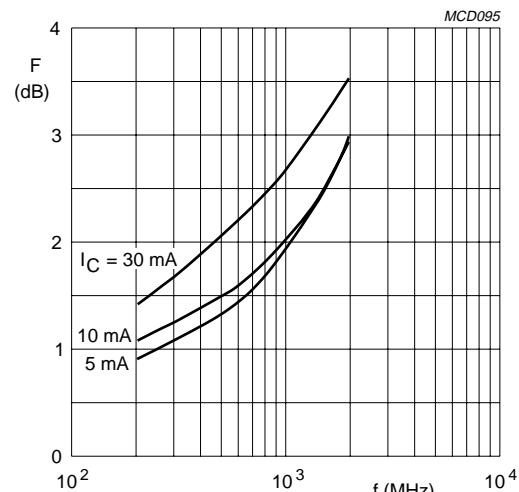
NPN 6 GHz wideband transistors

BFG93A; BFG93A/X



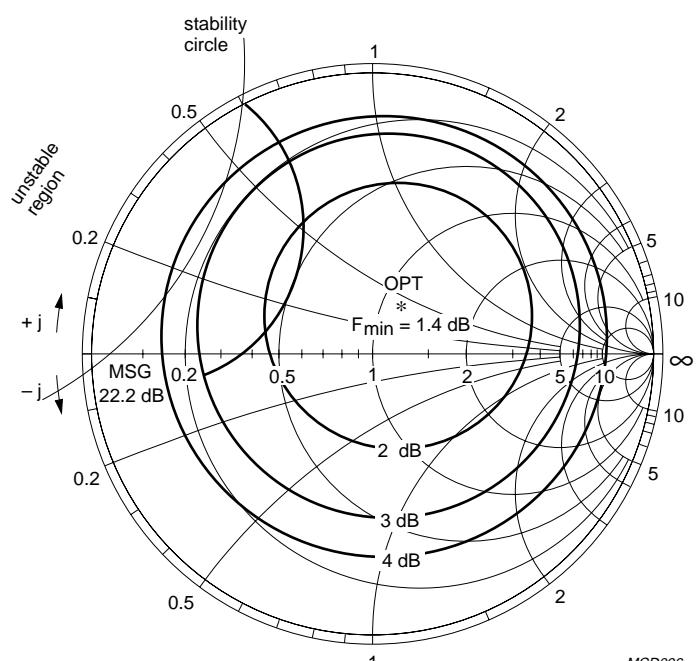
$$V_{CE} = 8 \text{ V.}$$

Fig.10 Minimum noise figure as a function of collector current; typical values.



$$V_{CE} = 8 \text{ V.}$$

Fig.11 Minimum noise figure as a function of frequency; typical values.



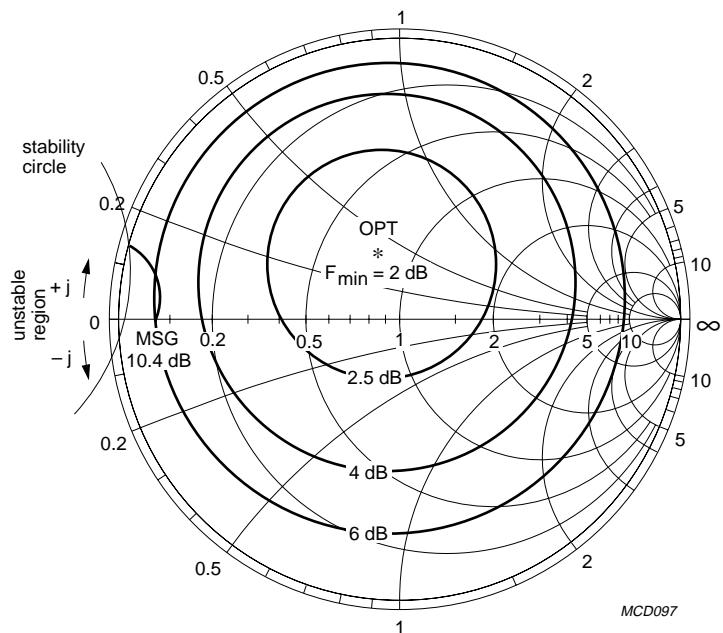
$$Z_0 = 50 \Omega.$$

Maximum stable gain = 22.2 dB.

Fig.12 Common emitter noise figure circles; typical values.

NPN 6 GHz wideband transistors

BFG93A; BFG93A/X

 $Z_0 = 50 \Omega$.

Maximum stable gain = 10.4 dB.

Fig.13 Common emitter noise figure circles; typical values.

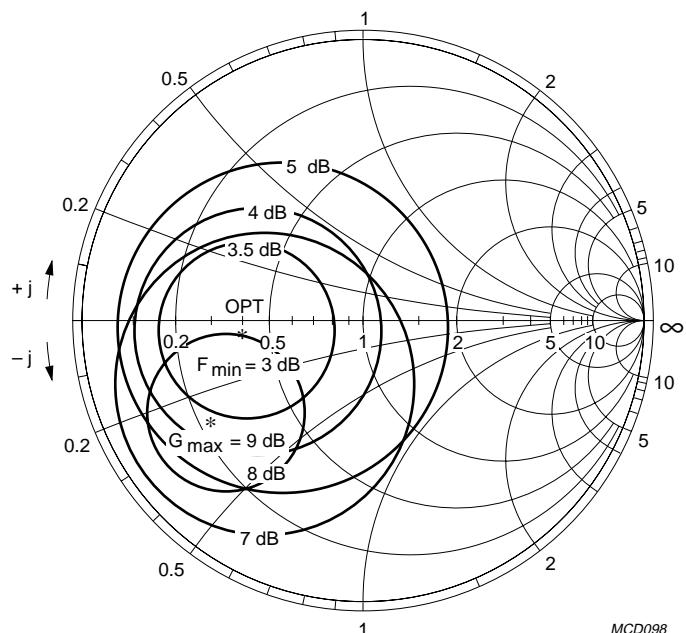
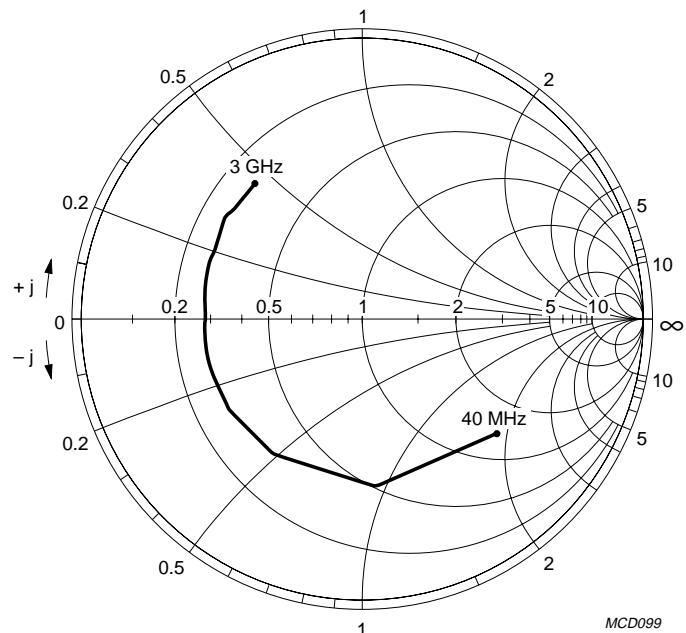
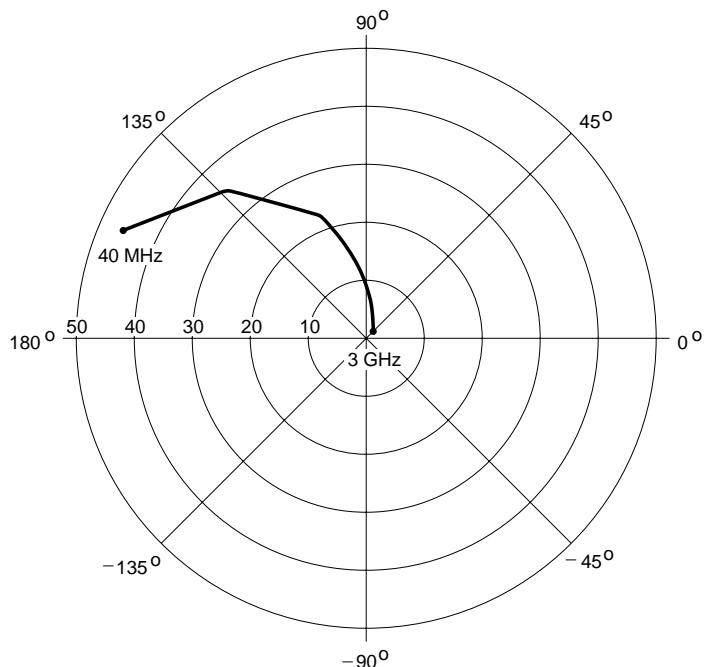
 $Z_0 = 50 \Omega$.

Fig.14 Common emitter noise figure circles; typical values.

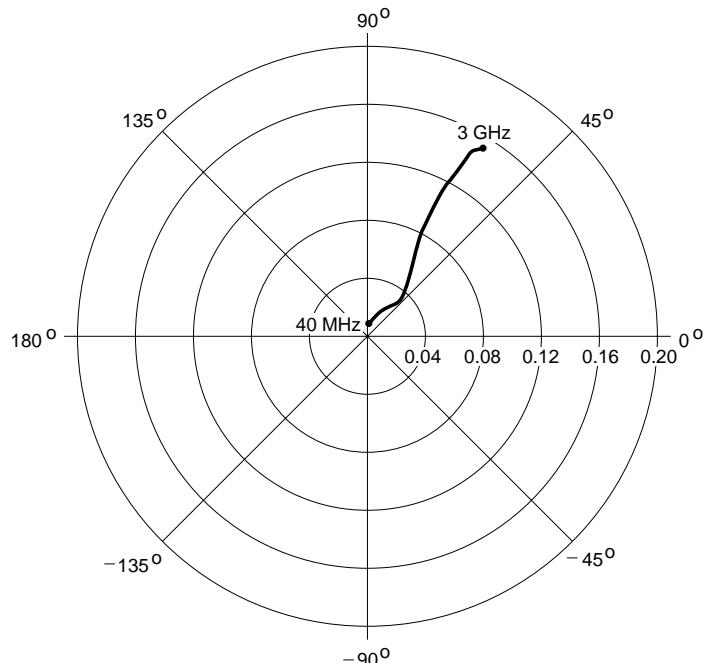
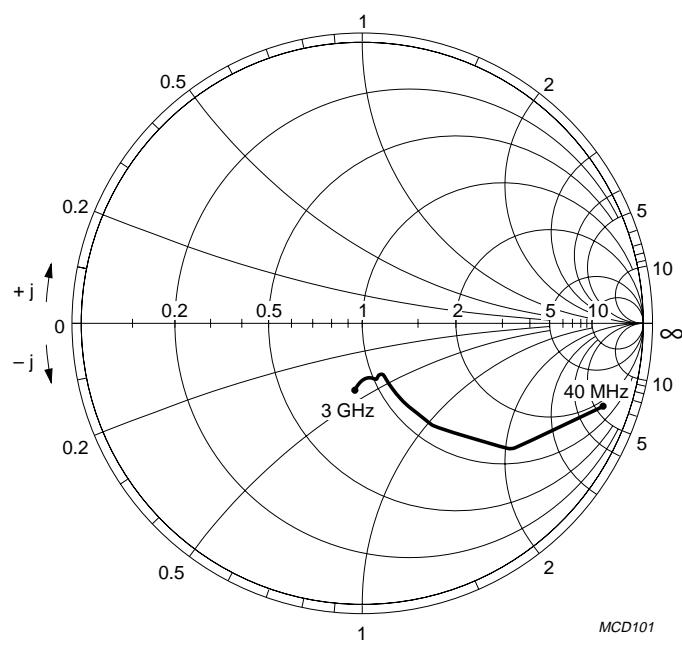
NPN 6 GHz wideband transistors

BFG93A; BFG93A/X

 $V_{CE} = 8 \text{ V}$; $I_C = 30 \text{ mA}$; $Z_o = 50 \Omega$.Fig.15 Common emitter input reflection coefficient (S_{11}). $V_{CE} = 8 \text{ V}$; $I_C = 30 \text{ mA}$; $R_{max} = 50 \Omega$.Fig.16 Common emitter forward transmission coefficient (S_{21}).

NPN 6 GHz wideband transistors

BFG93A; BFG93A/X

Fig.17 Common emitter reverse transmission coefficient (S_{12}).Fig.18 Common emitter output reflection coefficient (S_{22}).

NPN 6 GHz wideband transistors

BFG93A; BFG93A/X

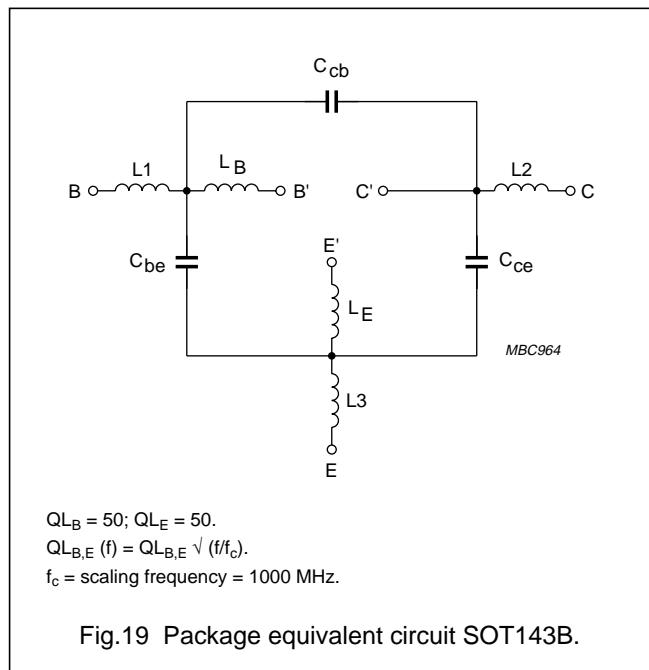
SPICE parameters for BFR91A(/X) die

| SEQUENCE No. | PARAMETER | VALUE | UNIT |
|--------------|-----------|-------|------|
| 1 | IS | 1.328 | fA |
| 2 | BF | 102.0 | – |
| 3 | NF | 1.000 | – |
| 4 | VAF | 51.90 | V |
| 5 | IKF | 8.155 | A |
| 6 | ISE | 13.90 | fA |
| 7 | NE | 15.12 | – |
| 8 | BR | 17.69 | – |
| 9 | NR | 994.0 | m |
| 10 | VAR | 3.280 | V |
| 11 | IKR | 10.00 | A |
| 12 | ISC | 1.043 | aA |
| 13 | NC | 1.189 | – |
| 14 | RB | 10.00 | Ω |
| 15 | IRB | 1.000 | μA |
| 16 | RBM | 10.00 | Ω |
| 17 | RE | 763.6 | mΩ |
| 18 | RC | 9.000 | Ω |
| 19 (note 1) | XTB | 0.000 | – |
| 20 (note 1) | EG | 1.110 | EV |
| 21 (note 1) | XTI | 3.000 | – |
| 22 | CJE | 2.032 | pF |
| 23 | VJE | 600.0 | mV |
| 24 | MJE | 290.0 | m |
| 25 | TF | 6.557 | ps |
| 26 | XTF | 38.97 | – |
| 27 | VTF | 10.93 | V |
| 28 | ITF | 521.0 | mA |
| 29 | PTF | 0.000 | deg |
| 30 | CJC | 1.003 | pF |
| 31 | VJC | 340.8 | mV |
| 32 | MJC | 194.2 | m |
| 33 | XCJC | 120.0 | m |
| 34 | TR | 3.073 | ns |
| 35 (note 1) | CJS | 0.000 | F |

| SEQUENCE No. | PARAMETER | VALUE | UNIT |
|--------------|-----------|-------|------|
| 36 (note 1) | VJS | 750.0 | mV |
| 37 (note 1) | MJS | 0.000 | – |
| 38 | FC | 800.0 | m |

Note

1. These parameters have not been extracted, the default values are shown.



List of components (see Fig.19)

| DESIGNATION | VALUE | UNIT |
|-----------------|-------|------|
| C _{be} | 84 | fF |
| C _{cb} | 17 | fF |
| C _{ce} | 191 | fF |
| L ₁ | 0.12 | nH |
| L ₂ | 0.21 | nH |
| L ₃ | 0.06 | nH |
| L _B | 0.95 | nH |
| L _E | 0.40 | nH |

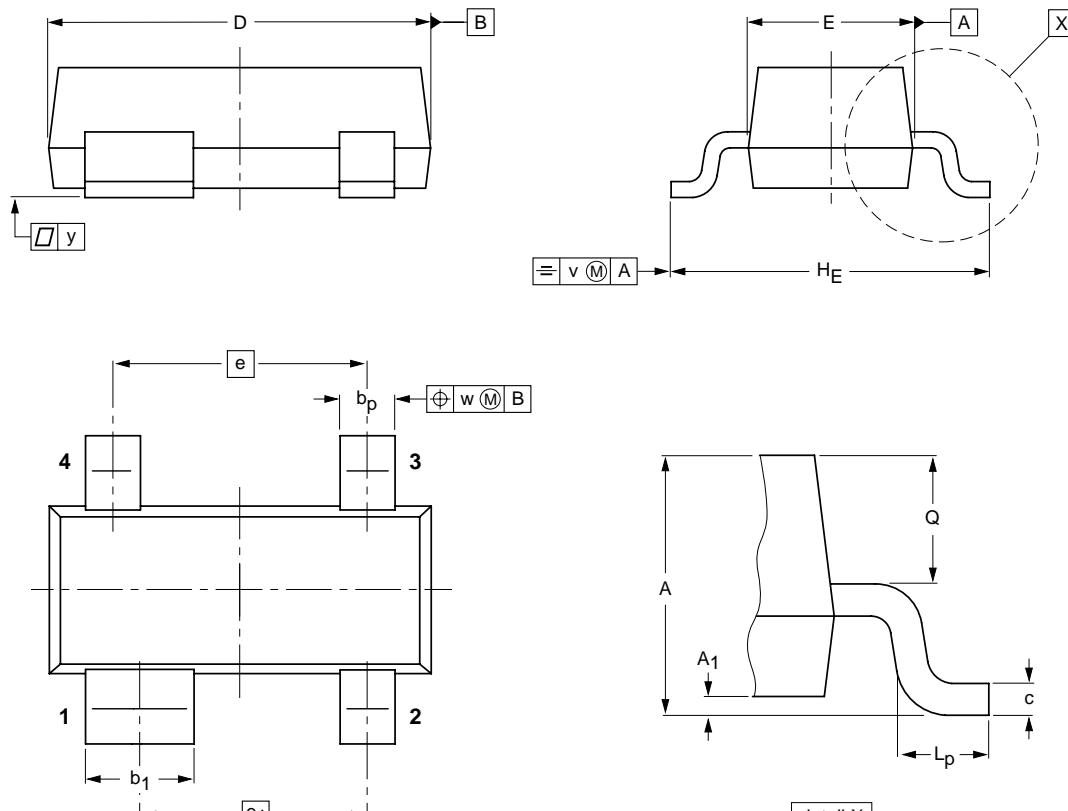
NPN 6 GHz wideband transistors

BFG93A; BFG93A/X

PACKAGE OUTLINE

Plastic surface mounted package; 4 leads

SOT143B



DIMENSIONS (mm are the original dimensions)

| UNIT | A | A ₁ max | b _p | b ₁ | c | D | E | e | e ₁ | H _E | L _p | Q | v | w | y |
|------|------------|-----------------------|----------------|----------------|--------------|------------|------------|-----|----------------|----------------|----------------|--------------|-----|-----|-----|
| mm | 1.1 0.9 | 0.1 | 0.48 0.38 | 0.88 0.78 | 0.15 0.09 | 3.0 2.8 | 1.4 1.2 | 1.9 | 1.7 | 2.5 2.1 | 0.45 0.15 | 0.55 0.45 | 0.2 | 0.1 | 0.1 |

| OUTLINE VERSION | REFERENCES | | | | EUROPEAN PROJECTION | ISSUE DATE |
|--------------------|------------|-------|------|--|------------------------|------------|
| | IEC | JEDEC | EIAJ | | | |
| SOT143B | | | | | | 97-02-28 |

Legal information

Data sheet status

| Document status ^{[1][2]} | Product status ^[3] | Definition |
|-----------------------------------|-------------------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nxp.com>.

Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Disclaimers

General — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof.

Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in medical, military, aircraft, space or life support equipment, nor in applications where failure or

malfuction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors accepts no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) may cause permanent damage to the device. Limiting values are stress ratings only and operation of the device at these or any other conditions above those given in the Characteristics sections of this document is not implied. Exposure to limiting values for extended periods may affect device reliability.

Terms and conditions of sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at <http://www.nxp.com/profile/terms>, including those pertaining to warranty, intellectual property rights infringement and limitation of liability, unless explicitly otherwise agreed to in writing by NXP Semiconductors. In case of any inconsistency or conflict between information in this document and such terms and conditions, the latter will prevail.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

Contact information

For additional information, please visit: <http://www.nxp.com>

For sales office addresses, send an email to: salesaddresses@nxp.com

Revision history

Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|--------------------------------|--------------|---|---------------|----------------|
| BFG93A_X_N_5 | 20071126 | Product data sheet | - | BFG93A_X_4 |
| Modifications: | | • Marking table on page 2; changed code | | |
| BFG93A_X_4 (9397 750 04351) | 19980923 | Product specification | - | BFG93SERIES_3 |
| BFG93SERIES_3 | 19950925 | Product specification | - | BFG93SERIES_2 |
| BFG93SERIES_2 | - | Product specification | - | BFG93_SERIES_1 |
| BFG93_SERIES_1 | - | - | - | - |

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

founded by

PHILIPS

© NXP B.V. 2007.

All rights reserved.

For more information, please visit: <http://www.nxp.com>

For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 26 November 2007

Document identifier: BFG93A_X_N_5

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[NXP](#):

[BFG93A/X,215](#) [BFG93A,215](#)